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Valid period: 12 months

Bulletin

We, CHIMEI CORPORATION, to the best of our knowledge hereby certify that the resins listed below (hereinafter referred as "products") as directly manufactured by us

WONDERLITE® PC PC-108U, PC-110(U), PC-110L, PC-110V, PC-115(U), PC-115L, PC-115P, PC-115P F01, PC-115P F17111C1, PC-122(U), PC-145K, PC-145K F01, PC-175

WONDERLOY® PC Alloy PC-330, PC-345, PC-365, PC-385, PC-860

conforms to the requirement that no chemicals as following are intentionally added.

1. Halogen (Br, I) and its compounds
2. Halogen (Cl)
3. PBDEs (Polybrominated Diphenyl Ethers)
4. PBBs (Polybrominated Biphenyls)
5. Ozone Depleting Chemicals (CFCs & HCFCs)
6. Chlorinated Paraffin (C10-C13)
7. Polyvinyl Chloride (PVC)
8. Mercury (Hg) and its compounds
9. Lead (Pb) and its compounds
10. Cadmium (Cd) and its compounds
11. Chromium (Cr) and its compounds
12. Arsenic (As) and its compounds
13. Antimony (Sb) and its compounds
14. Selenium (Se) and its compounds
15. Barium (Ba) and its compounds
16. Beryllium (Be) and its compounds
17. Bismuth (Bi) and its compounds
18. Organic tin compounds (TBT, TPT, DOT, DBT...etc)
19. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Naphtalenes (PCNs)
20. Poly naphthalenes
21. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8)
22. Asbestos
23. Phthalates
24. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE)
28. Triclosan
29. Nickel
30. PAHs (Polycyclic Aromatic Hydrocarbons)
31. REACH- Candidate List of SVHC
32. Radioactive Substances
33. Natural Latex
34. Dioxins and furans
35. Primary aromatic amines (PAA)
36. Perchlorate
37. Hexachlorobenzene
38. Mirex
39. Specified amine compounds
40. Benzene
41. Benzenamine, N-phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST)
42. Polyamide
43. PVDC (polyvinylidene chloride)
44. ESBO (Expoxidized soybean oil)
45. Formamide
46. Hexabromocyclododecane (HBCDD)
47. Red phosphorus
48. Aniline · formaldehyde polycondensate
49. Chlorobenzene
50. 4,4'-Sulfonyldiphenol (BPS)
51. Cobalt
52. PIP (3:1) (phenol, isopropylated phosphate 3:1)
53. DecaBDE (decabromodiphenyl ether)
54. 2,4,6-TTBP (2,4,6-Tris(tert-butyl)phenol)
55. HCBd (hexachlorobutadiene)

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- 25. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole
- 26. Formaldehyde
- 27. Dimethylfumarate (DMF)

- 56. PCTP (pentachlorothiophenol)
- 57. Perfluorooctanoic acid(PFOA), Perfluorooctane sulfonate(PFOS), Per-and polyfluoroalkyl substances (PFAS)

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS 2011/65/EU and its amendment (EU) 2015/863, TCO'07, Blue Angel and SONY Standard (SS-00259)

Sincerely Yours,

Jones. Kuo

Jones Kuo

Vice President of Research and Development Head Division

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